506465758 01/25/2021

# **PATENT ASSIGNMENT COVER SHEET**

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
QINCAN LI	01/22/2021

### **RECEIVING PARTY DATA**

Name:	BONSEN ELECTRONICS LIMITED
Street Address:	NO. 11-12, LUN PIN CHONG INDUSTRIAL ZONE
Internal Address:	SAN TUN COMMUNITY, HOU JIE TOWN DONGGUAN
City:	GUANGDONG
State/Country:	CHINA
Postal Code:	523960

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	17262813

# **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	V210101-USP (PCT)	
NAME OF SUBMITTER:	KARIN L. WILLIAMS	
SIGNATURE:	/Karin L. Williams/	
DATE SIGNED:	01/25/2021	
	This document serves as an Oath/Declaration (37 CFR 1.63).	

**Total Attachments: 1** 

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PATENT 506465758 REEL: 055014 FRAME: 0541

## ASSIGNMENT/DECLARATION FOR PATENT APPLICATION

WHEREAS, as a below named inventor, I hereby declare that:

The above application was made or authorized by me.

My residence, mailing address, and citizenship are as stated below next to my name. I believe I am the original inventor (if only one name is listed below) or an original joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

# VACUUM SEALING MACHINE CAPABLE OF LOCKING COVER AUTOMATICALLY HAVING UPPER COVER LIMITING MECHANISM

the specification of which is attached here	the specification	ı of which is	attached	hereto.
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• •	-	
WHEREASBONSEN ELECT	TRONICS LIMITED of CHINA	herein referred to
as "Assignee" whose mailing address is	No. 11-12, Lun Pin Chong Indus	trial Zone, San Tun
Community, Hou Jie Town Dongguan, Gua	angdong 523960, China	is desirous of
acquiring the entire right, title and interest i	in and to said invention, and in and	to and under any and all
Letters Patent to be obtained thereon.		

NOW, THEREFORE, for and in consideration of one Dollar (\$1.00) and other good and valuable considerations, the receipt of which is hereby acknowledged, I/we the inventor(s) have sold, assigned and transferred, and by these presents do hereby sell, assign and transfer unto the Assignee, its successors and assigns the entire right, title and interest in and to said invention, said application and the Letters Patent, both foreign and domestic, that may or shall issue, including all of my rights under International Convention, and I/we do hereby authorize and request the Commissioner of Patents and Trademarks to issue said Letters Patent to the Assignee in accordance herewith.

Upon said consideration, I/we do hereby covenant and agree with the said Assignee, its successors and assigns, that I/we will not execute any writing or do any act whatsoever conflicting with these presents, and that I/we or my/our executors or administrators will at any time upon request, without further or additional consideration, but at the expense of the said Assignee, its successors and assigns, execute such additional writings and do such additional acts as said Assignee, its successors and assigns, may deem necessary or desirable to perfect the Assignee's enjoyment of this grant, and render all necessary assistance in making application for and obtaining original, divisional, continuation, reissued or extended Letters Patent of the United States, or of any and all foreign countries on said invention, and in enforcing any rights, occurring as a result of such applications or patents, by giving testimony in any proceedings or transactions involving such applications or patents.

I/We hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Full Name of Sol	e or First Inventor: Li, Qincan	
Residence: No. 11-12, Lun Pin Chong Industrial Zone, San Tun Community, Hou Jie Town Dongguan, Guangdong 523960, China		
Mailing Address: No. 11-12, Lun Pin Chong Industrial Zone, San Tun Community, Hou Jie Town Dongguan, Guangdong 523960, China		
Country:	China	
Inventor's Signature:	Li, Qincan	01/22/2021 Date:

PATENT REEL: 055014 FRAME: 0542

RECORDED: 01/25/2021